506447524 01/13/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6494293

		NEW ASSIGNMENT	
		ASSIGNMENT	
CONVEYING PARTY D	ΑΤΑ		
		Name	Execution Date
JUN HYUNG KIM		01/06/2021	
SANG YOON JI	G YOON JI		01/06/2021
JANG-UNG PARK			01/06/2021
Street Address: City: State/Country:	26, JONG-RO, JONGNO-GU SEOUL KOREA, REPUBLIC OF		
Postal Code:	03188		
Name:	INDUSTRY-ACADEMIC COOPERATION FOUNDATION, YONSEI UNIVERSITY		
Street Address:	50, YONSEI-RO, SEODAEMUN-GU		
City:	SEOUL		
State/Country:	KOREA, REPUBLIC OF		

PROPERTY NUMBERS Total: 1

Postal Code:

Property Type	Number
Application Number:	17147917

03722

CORRESPONDENCE DATA

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Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.			
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Email:	assignments@webblaw.com		
Correspondent Name:	THE WEBB LAW FIRM, P.C.		
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ATTORNEY DOCKET NUMBER		5038-2100009	
NAME OF SUBMITTER:		RICHARD L. BYRNE REG.#28498	

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PATENT REEL: 054906 FRAME: 0728

SIGNATURE:	/Richard L. Byrne/
DATE SIGNED:	01/13/2021
Total Attachments: 3 source=Assignment#page1.tif source=Assignment#page2.tif source=Assignment#page3.tif	

Application No.

Attorney Docket No. _____5038-2100009____

ASSIGNMENT

WHEREAS, as a below named inventor, I have invented certain new and useful
improvements in
TOUCH SENSOR WITH FINGERPRINT SENSOR
(Invention Title)
X for which I have this day executed an application for a United States Patent (hereinafter "said application").
AND/OR
for which an application for a United States Patent was filed on(mm/dd/yyyy) and bears Application Number (hereinafter "said application").
AND/OR
for which an international patent application was filed under the Patent Cooperation Treaty on (mm/dd/yyyy), bearing Application No. (hereinafter
on (mm/dd/yyyy), bearing Application No (hereinafter "said application").
AND, WHEREAS, SK Innovation Co., Ltd., a corporation of the Republic of Korea, having a place of business at 26, Jong-ro Jongno-gu, Seoul 03188, Republic of Korea, and
Industry-Academic Cooperation Foundation, Yonsei University, a university of the Republic of Korea, having a place of business at 50, Yonsei-ro, Seodaemun-gu, Seoul 03722, Republic of Korea, hereinafter called the "assignees", are desirous of acquiring the entire right, title, and interest in and to said application and the inventions and improvements therein disclosed.
NOW, THEREFORE, for good and valuable consideration paid to me by said

assignees, the receipt of which is hereby acknowledged. I as the inventor or as one of the inventors, hereinafter the assignor(s), do hereby assign, sell and transfer unto said assignees the full and exclusive right, title and interest in and to said application and the inventions and improvements therein disclosed for the United States and all foreign countries, including rights of priority under the International Convention of Paris (1883) as amended, and any Letters Patent which may issue therefor in the United States and all foreign countries and all divisions, reissues, continuations, continuations-in-part, renewals and/or extensions thereof. Such assignment extends to the full ends of the terms of these applications and patents as fully and entirely as the same would have been held and enjoyed by me had this Assignment not been made.

I hereby authorize and request any attorney associated with The Webb Law Firm, Customer No. 28289, to insert here in parentheses (Application No. 17/147,917, filed 01/13/2021) the filing date and application number of said application when known.

I covenant that I am the lawful owner(s) of said application, inventions and improvements, that the same are unencumbered, that no license has been granted to make, use or vend the said inventions or improvements or any of them, and that I have the full right to make this Assignment.

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And for the consideration aforesaid, I agree individually and, if applicable, jointly that I will communicate to said assignces or the representatives thereof any facts known to me respecting said inventions and improvements, and will, upon request but without expense to me, testify in any legal proceedings, sign all lawful papers, execute all divisional, reissue, continuation, continuation-in-part, renewal and/or extension applications, make all rightful oaths, and generally do all other and further lawful acts deemed necessary or expedient by said assignces or by counsel for said assignces to assist or enable said assignces to obtain and enforce full benefits from the rights and interests herein assigned. This Assignment shall be binding upon my heirs, executors, administrators and/or assigns, and shall inure to the benefit of the heirs, executors, administrators, successors and/or assigns, as the case may be, of said assignces.

1. FULL NAME OF ASSIGNOR:	RESIDENCE:
Jun Hyung Kim	Daejeon, Republic of Korea
EXECUTED this <u>6th</u> day of <u>John</u>	_, 2021 Juny Minature
WITNESS:	
2. FULL NAME OF ASSIGNOR:	RESIDENCE:
Sang Yoon Ji	Daejeon, Republic of Korea
EXECUTED this <u>6th</u> day of <u>Jan</u>	_, 2021 Sangyoon Ji Signature
	SIGNATURE
WITNESS:	
	_
X Checked Box indicates <u>1</u> additional	page for inventor signatures.

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3. FULL NAME OF ASSIGNOR: Jang-Ung Park	RESIDENCE: Seoul, Republic of Korea	
EXECUTED this <u>IIL</u> day of <u>Jan</u>	, 2021	XA
		Signature
WITNESS:		

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